



Joc. Number :
Tentative Specification
Preliminary Specification
Approval Specification

MODEL NO.: M270HGE SUFFIX: L30

Customer:	
APPROVED BY	SIGNATURE
Name / Title Note Product Version C4	
Please return 1 copy for your signature and comments.	our confirmation with your

Checked By	Prepared By
	Checked By

Version 3.2 17 December 2015 1 /35



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REVISION HISTORY

ate	Page	Description						
sep.06, 2013	All	Approval Spec Ver.	pproval Spec Ver.3.0 was first issued.					
pr.28,2015	16	Revise 4.5 Vtotal M	Revise 4.5 Vtotal Max 1136>1250					
	18	Revise 4.6 T2 Value	es 0~50)ms -> 50~	100ms			
ec.14,2015	1	Revise Product Ver	rsion C1	/C2→C4				
		Original:		umption cha		7.0 solution	٦.	
		Parameter	Symbol	Min.	Тур.	Max.	Unit	Note (1)
		LED Light Bar Input Voltage Per Input Pin	VPIN		55.8	60.3	V	(1), Duty=100%, IPIN=85mA
		Per Input Pin	IPIN	40000	85	89	mA Hrs	(1), (2) Duty=100% (3)
	12	Power Consumption	PBL	10000	18.97	20.5	W	(1) Duty=100%, IPIN=85mA
					Value∂		∐nit∂	Note₽
								(1),4
		Voltage Per Input Pin₽					'	Duty=100%,← IPIN=75mA≠ (1), (2)←
		Per Input Pin₽			75₽	804	mA-≀ Hrs-≀	Duty=100%₽
		Power Consumption₽	PBL₽	Þ	16.32₽	17.34₽	W₽	(1)+- Duty=100%,+- IPIN=75mA+-
	ep.06, 2013 pr.28,2015	ep.06, 2013 All pr.28,2015 16	ep.06, 2013 All Approval Spec Ver. pr.28,2015 16 Revise 4.5 Vtotal M 18 Revise 4.6 T2 Valu ec.14,2015 1 Revise Product Ver Backlight unit Power Original: 4.3.3 BACKLIGHT U Parameter LED Light Bar Input Voltage Per Input Pin LED Life Time Power Consumption 12 Change to: 4.3.3 BACKLIGHT U Parameter LED Light Bar Input Voltage Per Input Pin LED Light Bar Input Voltage Per Input Pin LED Light Bar Current Per Input Pin LED Light Bar Current	ep.06, 2013 All Approval Spec Ver.3.0 was pr.28,2015 16 Revise 4.5 Vtotal Max 1136 18 Revise 4.6 T2 Values 0~50 ec.14,2015 1 Revise Product Version C1 Backlight unit Power Cons Original: 4.3.3 BACKLIGHT UNIT Parameter Symbol LED Light Bar Input VPIN LED Light Bar Current Per Input Pin LED Life Time LLED Power Consumption PBL 12 Change to: 4.3.3 BACKLIGHT UNIT Parameter Symbol LED Light Bar Input VPIN LED Light Bar Input Voltage Per Input Pin LED Light Bar Current Parameter Symbol LED Light Bar Current Per Input Pin LED Light Fine LED Light Fine	ep.06, 2013 All Approval Spec Ver.3.0 was first issued pr.28,2015 16 Revise 4.5 Vtotal Max 1136>1250 18 Revise 4.6 T2 Values 0~50ms →> 50~ Revise Product Version C1/C2→C4 Backlight unit Power Consumption chat Original: 4.3.3 BACKLIGHT UNIT Parameter Symbol Min. LED Light Bar Input VPIN LED Life Time LLED 40000 Power Consumption PBL Change to: 4.3.3 BACKLIGHT UNIT Change to: 4.3.3 BACKLIGHT UNIT Parameter Symbol Min. LED Light Bar Current PBL Change to: 4.3.3 BACKLIGHT UNIT Parameter Symbol Min. LED Light Bar Input VPIN LED Light Bar Input VPIN LED Light Bar Current PIN Per Input Pin LED Light Bar Current PIN Per Input Pin LED Light Fine LLED 50000 LED LIGHT FIN	ep.06, 2013 All Approval Spec Ver.3.0 was first issued. pr.28,2015 16 Revise 4.5 Vtotal Max 1136>1250 18 Revise 4.6 T2 Values 0~50ms -> 50~100ms ec.14,2015 1 Revise Product Version C1/C2→C4 Backlight unit Power Consumption change to ES: Original: 4.3.3 BACKLIGHT UNIT Parameter Symbol Value Parameter Symbol Min. Typ. LED Light Bar Input VPIN 55.8 LED Light Bar Current Per Input Pin LED Life Time LLED 40000 Power Consumption PBL 18.97 Change to: 4.3.3 BACKLIGHT UNIT Parameter Symbol Min. Value 18.97 Change to: 4.3.3 BACKLIGHT UNIT LED Light Bar Input VPIN 54.4€ LED Light Bar Current Per Input Pin VPIN 55.4 LED Light Bar Current Per Input Pin VPIN 65.4 LED Light Bar Current Per Input Pin VPIN 65.4 LED Light Bar Current Per Input Pin 65.5 LED Light Bar Current P	ep.06, 2013 All Approval Spec Ver.3.0 was first issued. pr.28,2015 16 Revise 4.5 Vtotal Max 1136>1250 18 Revise 4.6 T2 Values 0~50ms → 50~100ms ec.14,2015 1 Revise Product Version C1/C2→C4 Backlight unit Power Consumption change to ES7.0 solution Original: 4.3.3 BACKLIGHT UNIT Parameter Symbol Min. Typ. Max. LED Light Bar Input VPIN 55.8 60.3 LED Light Bar Current Per Input Pin LED Life Time LLED 40000 Power Consumption PBL 18.97 20.5 Change to: 4.3.3 BACKLIGHT UNIT Parameter Symbol Min. Typ. Max. LED Light Bar Input VPIN 85 89 LED Light Bar Input VPIN 85 89 LED Light Bar Input VPIN 9 54.4 57.8 57.8 57.8 57.8 57.8 57.8 57.8 57.8	ep.06, 2013 All Approval Spec Ver.3.0 was first issued. pr.28,2015 16 Revise 4.5 Vtotal Max 1136>1250 18 Revise 4.6 T2 Values 0~50ms → 50~100ms ec.14,2015 1 Revise Product Version C1/C2→C4 Backlight unit Power Consumption change to ES7.0 solution. Original: 4.3.3 BACKLIGHT UNIT Parameter Symbol Min. Typ. Max. Unit Voltage Per Input Pin LED Light Bar Current Per Input Pin LED Life Time LLED 40000 Hrs Parameter Symbol Nin. Typ. Max. Unit Notage Per Input Pin LED Life Time LLED 40000 Hrs Power Consumption PBL 18.97 20.5 W Change to: 4.3.3 BACKLIGHT UNIT Parameter Symbol Min. Typ. Max. Unit Notage Per Input Pin Voltage



1. GENERAL DESCRIPTION

1.1 OVERVIEW

M270HGE-L30 is a 27.0" TFT Liquid Crystal Display MNT module with WLED Backlight unit and 30 pins 2ch-LVDS interface. This module supports 1920×1080 Full HD mode and can display up to 16.7M colors. The converter module for Backlight is not built in.

1.2 GENERAL SPECIFICATIONS

Item	Specification	Unit	Note
Screen Size	597.89 (H) X 336.31 (V), (27.0 inch Diagonal)	mm	
Driver Element	a-si TFT active matrix	-	-
Pixel Number	1920 x R.G.B. x 1080	pixel	-
Pixel Pitch	0.3114 (H) x 0.3114 (V)	mm	-
Pixel Arrangement	RGB vertical stripe	-	-
Display Colors	16.7M	color	-
Transmissive Mode	Normally white	-	-
Surface Treatment	AG type, 3H hard coating, Haze 25	-	-
Luminance, White	300	Cd/m2	
RoHS,Halogen Free &TCO 6.0	RoHS, Halogen Free TCO 6.0 compliance		
Power Consumption	Total 22.42W(Typ.) @ cell 6.1W(Max.), BL 16.32	2W(Typ.)	(1)

Note (1) The specified power consumption: Total= cell (reference 4.3.1)+BL (reference 4.3.3)

2. MECHANICAL SPECIFICATIONS

Item		Min.	Тур.	Max.	Unit	Note
	Horizontal (H)	629.5	630.0	630.5	mm	
Module Size	Vertical (V)	367.7	368.2	368.7	mm	(1)
	Thickness (T)	13.6	14.1	14.6	mm	
Bezel Area	Horizontal	603.4	603.9	604.4	mm	
Dezei Alea	Vertical	341.8	342.3	342.8	mm	
Active Area	Horizontal	1	597.89	-	mm	
Active Area	Vertical	-	336.31	-	mm	
Weight		2460	2530	2600	g	

Note (1) Please refer to the attached drawings for more information of front and back outline dimensions.



3. ABSOLUTE MAXIMUM RATINGS

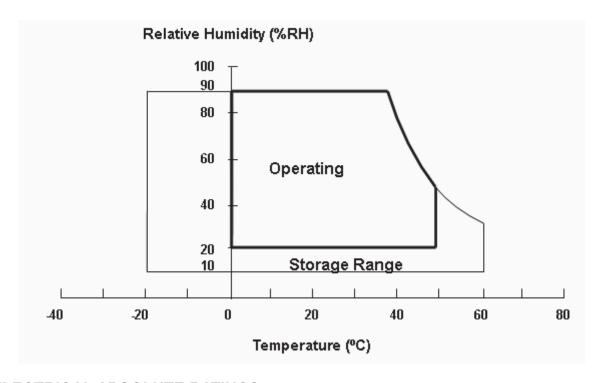
3.1 ABSOLUTE RATINGS OF ENVIRONMENT

Item	Symbol	Va	lue	Unit	Note
цет	Syllibol	Min.	Max.	Offic	Note
Storage Temperature	TST	-20	60	ºC	(1)
Operating Ambient Temperature	TOP	0	50	ºC	(1), (2)

Note (1)

- (a) 90 %RH Max.
- (b) Wet-bulb temperature should be 39 °C Max.
- (c) No condensation.

Note (2) Panel surface temperature should be 0° C min. and 65° C max under Vcc=5.0V, fr =60Hz, typical LED string current, 25° C ambient temperature, and no humidity control. Any condition of ambient operating temperature, the surface of active area should be keeping not higher than 65° C.



3.2 ELECTRICAL ABSOLUTE RATINGS

3.2.1 TFT LCD MODULE

ltem	Item Symbol Value			Unit	Note
item	Cymbol	Min.	Max.	Offic	14010
Power Supply Voltage	VCCS	-0.3	6.0	V	(1)
Logic Input Voltage	VIN	-0.3	3.6	V	(1)

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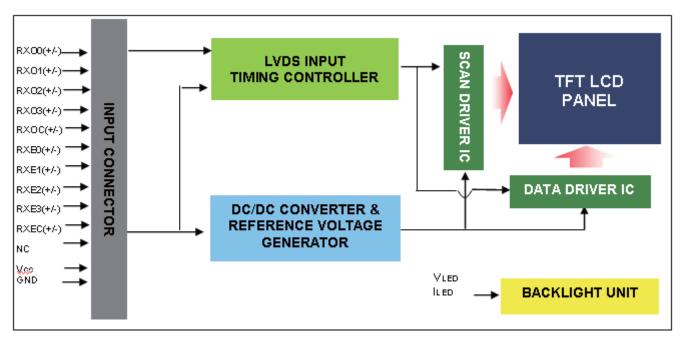
3.2.2 BACKLIGHT UNIT

ltem	Symbol		Value		Unit	Note
item	Symbol	Min.	Тур	Max.	Offic	Note
LED Forward Current Per Input Pin	IF		75	80	mA	(1), (2) Duty=100%
LED Pulse Forward Current Per Input Pin	ΙP			570	mA	(1), (2) Pulse Width≦10msec. and Duty≦10%

- Note (1) Permanent damage to the device may occur if maximum values are exceeded. Function operation should be restricted to the conditions described under Normal Operating Conditions.
- Note (2) Specified values are for input pin of LED light bar at Ta=25±2 °C (Refer to 4.3.3 and 4.3.4 for further information).

4. ELECTRICAL SPECIFICATIONS

4.1 FUNCTION BLOCK DIAGRAM





4.2. INTERFACE CONNECTIONS

PIN ASSIGNMENT

Pin	Name	Description
1	RXO0-	Negative LVDS differential data input. Channel O0 (odd)
2	RXO0+	Positive LVDS differential data input. Channel O0 (odd)
3	RXO1-	Negative LVDS differential data input. Channel O1 (odd)
4	RXO1+	Positive LVDS differential data input. Channel O1 (odd)
5	RXO2-	Negative LVDS differential data input. Channel O2 (odd)
6	RXO2+	Positive LVDS differential data input. Channel O2 (odd)
7	GND	Ground
8	RXOC-	Negative LVDS differential clock input. (odd)
9	RXOC+	Positive LVDS differential clock input. (odd)
10	RXO3-	Negative LVDS differential data input. Channel O3(odd)
11	RXO3+	Positive LVDS differential data input. Channel O3 (odd)
12	RXE0-	Negative LVDS differential data input. Channel E0 (even)
13	RXE0+	Positive LVDS differential data input. Channel E0 (even)
14	GND	Ground
15	RXE1-	Negative LVDS differential data input. Channel E1 (even)
16	RXE1+	Positive LVDS differential data input. Channel E1 (even)
17	GND	Ground
18	RXE2-	Negative LVDS differential data input. Channel E2 (even)
19	RXE2+	Positive LVDS differential data input. Channel E2 (even)
20	RXEC-	Negative LVDS differential clock input. (even)
21	RXEC+	Positive LVDS differential clock input. (even)
22	RXE3-	Negative LVDS differential data input. Channel E3 (even)
23	RXE3+	Positive LVDS differential data input. Channel E3 (even)
24	GND	Ground
25	NC	For LCD internal use only, Do not connect
26	NC	For LCD internal use only, Do not connect
27	NC	For LCD internal use only, Do not connect
28	Vcc	+5.0V power supply
29	Vcc	+5.0V power supply
30	Vcc	+5.0V power supply
	-	

Connector Information

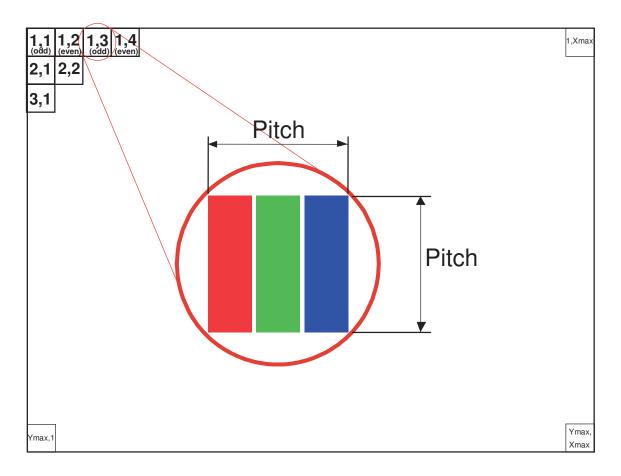
Item	Description					
Manufacturer	P-TWO / Foxconn					
Type part number	P-TWO: 187114-30091					
	Foxconn: GS23301-1321S-7H					
User's Mating housing part number	JAE: FI-X30HL()					
	Foxconn: WM13-011-3050					

*Notice: There would be compatible issues if not using the indicated connectors in the matching list.

Note (1) The first pixel is odd.

Note (2) Input signal of even and odd clock should be the same timing.





4.3 ELECTRICAL CHARACTERISTICS

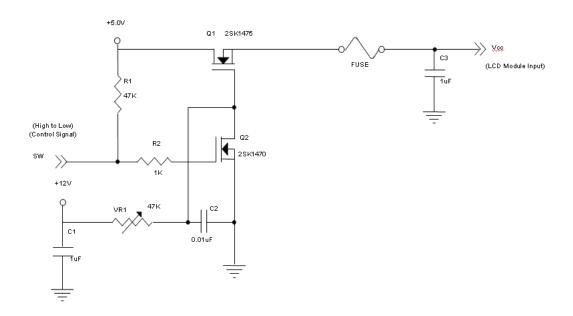
4.3.1 LCD ELETRONICS SPECIFICATION

	Parameter		Symbol		Value		Unit	Note
	Faranie	;tei	Symbol	Min.	Тур.	Max.	Offic	Note
	Power Supply Voltage			4.5	5.0	5.5	V	-
	Ripple Vo	Itage	V_{RP}			300	mV	-
	Rush Cu	rrent	I _{RUSH}			3	Α	(2)
		White			0.46	0.51	Α	(3)a
Power Su	pply Current	Black			1.08	1.22	Α	(3)b
		Vertical Stripe			1.03	1.16	Α	(3)c
	Power Cons	umption	PLCD		5.4	6.1	Watt	(4)
	Differenti	al Input Voltage	V_{ID}	100	-	600	mV	
	Commo	n Input Voltage	V_{CM}	1.0	1.2	1.4	V	
LVDS interface	Differer Thres	V _{TH}	-	-	+100	mV		
		ntial Input Low hold Voltage	V _{TL}	-100	-	-	mV	

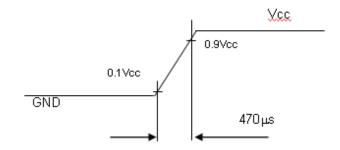
Note (1) The ambient temperature is $Ta = 25 \pm 2$ $^{\circ}C$.

Note (2) Measurement Conditions:



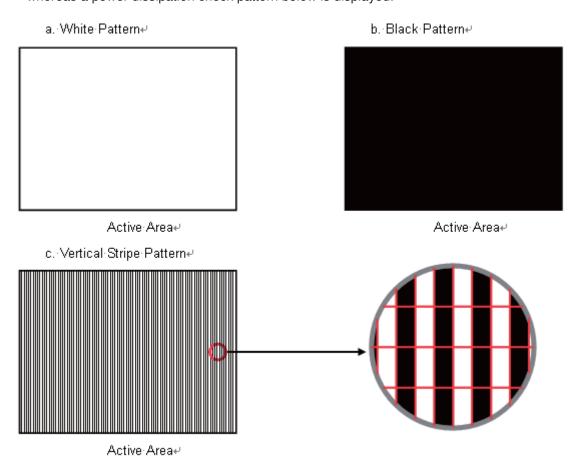


Vcc rising time is 470μs



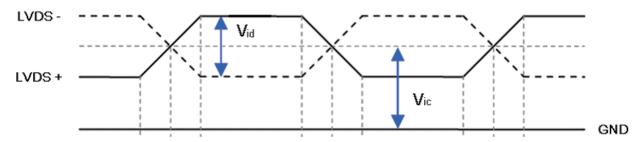


Note (3) The specified power supply current is under the conditions at Vcc = 5.0 V, $Ta = 25 \pm 2 \,^{\circ}\text{C}$, Fr = 60 Hz, whereas a power dissipation check pattern below is displayed.



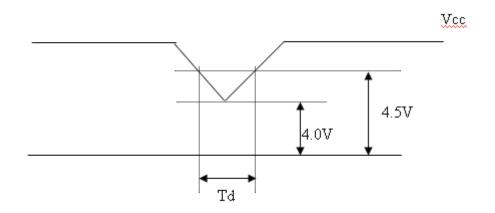
Note (4) The power consumption is specified at the pattern with the maximum current.

Note (5) VID waveform condition





4.3.2 VCC POWER DIP CONDITION

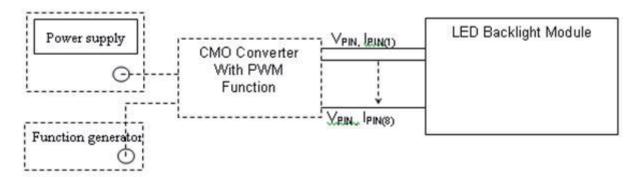


Dip condition: 4.0 ≤ Vcc ≤ 4.5, Td ≤ 20ms

4.3.3 BACKLIGHT UNIT

Parameter	Symbol		Value		Unit	Note
raidilletei	Syllibol	Min.	Тур.	Max.	Offic	Note
LED Light Bar Input Voltage Per Input Pin	VPIN		54.4	57.8	V	(1), Duty=100%, IPIN=75mA
LED Light Bar Current Per Input Pin	IPIN		75	80	mA	(1), (2) Duty=100%
LED Life Time	LLED	50000			Hrs	(3)
Power Consumption	PBL	,	16.32	17.34	W	(1) Duty=100%, IPIN=75mA

- Note (1) LED light bar input voltage and current are measured by utilizing a true RMS multimeter as shown below:
- Note (2) $PBL = IPIN \times VPIN \times (4)$ input pins.
- Note (3) The lifetime of LED is defined as the time when LED packages continue to operate under the conditions at Ta = 25 \pm 2 $^{\circ}$ C and I= (75)mA (per chip) until the brightness becomes \leq 50% of its original value.
- Note (4) The module must be operated with constant driving current.

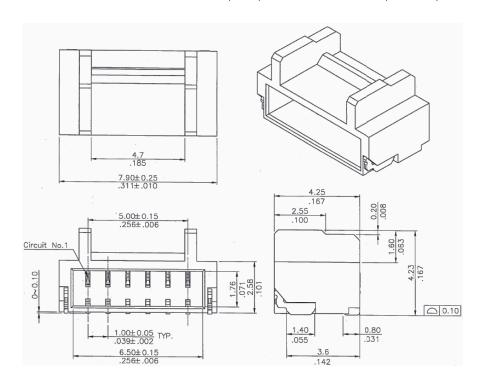


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4.3.4 LIGHTBAR CONNECTOR PIN ASSIGNMENT

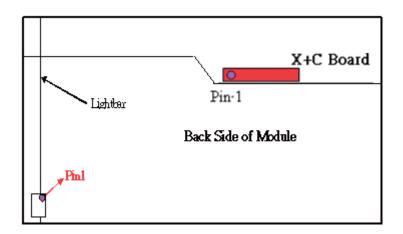
Connector:WM13-406-063N(FCN), CI1406M1HRK-NH(CVILUX).



CN1

Pin number	Description						
1	Cathode of LED string						
2	Cathode of LED string						
3	VLED						
4	VLED						
5	Cathode of LED string						
6	Cathode of LED string						

Note (1) User's Mating Connector Part No.: Cl1406SL000-NH (CviLux) or Compatible.



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4.4 LVDS INPUT SIGNAL SPECIFICATIONS

4.4.1 LVDS DATA MAPPING TABLE

LVDS Channel O0	LVDS output	D7	D6	D4	D3	D2	D1	D0
LVD3 Ghanner O0	Data order	OG0	OR5	OR4	OR3	OR2	OR1	OR0
LVDS Channel O1	LVDS output	D18	D15	D14	D13	D12	D9	D8
LVD3 GHarifiel O1	Data order	OB1	OB0	OG5	OG4	OG3	OG2	OG1
LVDS Channel O2	LVDS output	D26	D25	D24	D22	D21	D20	D19
LVD3 Ghanner O2	Data order	DE	NA	NA	OB5	OB4	OB3	OB2
LVDS Channel O3	LVDS output	D23	D17	D16	D11	D10	D5	D27
LVD3 Channel O3	Data order	NA	OB7	OB6	OG7	OG6	OR7	OR6
LVDS Channel E0	LVDS output	D7	D6	D4	D3	D2	D1	D0
LVD3 GHAHHELEU	Data order	EG0	ER5	ER4	ER3	ER2	ER1	ER0
LVDS Channel E1	LVDS output	D18	D15	D14	D13	D12	D9	D8
LVD3 GHAHHELET	Data order	EB1	EB0	EG5	EG4	EG3	EG2	EG1
LVDS Channel E2	LVDS output	D26	D25	D24	D22	D21	D20	D19
LVD3 GHarifiel E2	Data order	DE	NA	NA	EB5	EB4	EB3	EB2
LVDS Channel E3	LVDS output	D23	D17	D16	D11	D10	D5	D27
LVD3 GHaffilet E3	Data order	NA	EB7	EB6	EG7	EG6	ER7	ER6



4.4.2 COLOR DATA INPUT ASSIGNMENT

The brightness of each primary color (red, green and blue) is based on the 8-bit gray scale data input for the color. The higher the binary input, the brighter the color. The table below provides the assignment of color versus data input.

					_							Da		Sigr											
	Color				Re	ed								reer	1						Βlι	Je			
		R7	R6	R5	R4	R3	R2	R1	R0	G 7	G 6	G 5	G 4	G3	G2	G1	G0	B 7	B6	B5	B4	ВЗ	B2	B 1	B 0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
Basic	Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
Colors	Cyan	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Red(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1)	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray	Red(2)	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	:	:	:	:	:	:	١.	:		:	_	:	_	:	:	:	_		:		:	:	:	:	
Red	Red(253)	1	1	1	1	1	1	0	1	0	0	0	:0	0	0	0	0	0	0	0	0	0	0	0	:0
	Red(254)	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
Gray	Green(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
Scale	:				1		:		:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
Of	Cross(0E0)	:	:	:		:		:	:	: 4		1	;	:	-	:	: 1	:		:	:	:	:	:	
Green	Green(253)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0
	Green(254) Green(255)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0 1	0	0	0	0	0	0	0	0
	Blue(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	_	0	-			0	0		0	0	0	0	0
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		0	0	0
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	l		0	0	0	0	1
Gray	blue(2)					:							:				:		0	0	0	0	0	1	0
Scale		:		:	:	:	:	:	:	:	:	:	:		:	:		:	:	:		:	:	:	
Of	Blue(253)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	:	1	1	i	1	1	: 1		1
Blue	Blue(254)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	
	Blue(254)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0
	Dido(200)	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U						l I	-1	ı

Note (1) 0: Low Level Voltage, 1: High Level Voltage



4.5 DISPLAY TIMING SPECIFICATIONS

The input signal timing specifications are shown as the following table and timing diagram.

Signal	Item	Symbol	Min.	Тур.	Max.	Unit	Note
	Frequency	Fc	54.54	74	98	MHz	-
	Period	Tc	-	13.5	-	ns	
	Input cycle to cycle jitter	T_{rcl}	-0.02*Tc	-	0.02*Tc	ns	(1)
	Input Clock to data skew	TLVCCS	-400	0	400	ps	(2)
LVDS Clock	Spread spectrum modulation range	Fclkin_ mod	0.97*Fc		1.03*Fc	MHz	(2)
	Spread spectrum modulation frequency	F _{SSM}			200	KHz	(3)
	Frame Rate	Fr	47	60	75	Hz	Tv=Tvd+Tvb (4)
Vertical Display Term	Total	Tv	1105	1125	1250	Th	-
vertical display ferrif	Active Display	Tvd	1080	1080	1080	Th	-
	Blank	Tvb	25	45	170	Th	-
	Total	Th	1050	1100	1150	Tc	Th=Thd+Thb
Horizontal Display Term	Active Display	Thd	960	960	960	Тс	-
	Blank	Thb	90	140	190	Tc	-

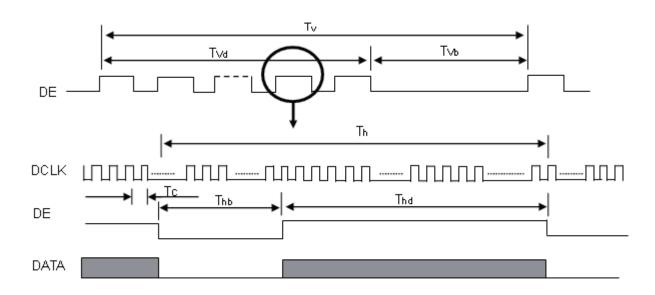
Note1: Because this module is operated by DE only mode, Hsync and Vsync input signals are ignored.

Note2: Please make sure the range of pixel clock has follow the below equation:

 $Fc(max) \ge Fr \times Tv \times Th$

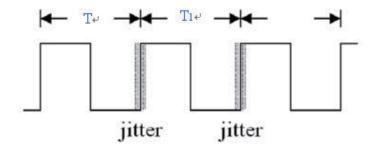
 $Fr \times Tv \times Th \ge Fc(min)$

INPUT SIGNAL TIMING DIAGRAM

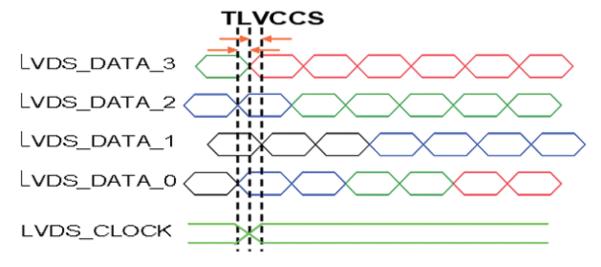




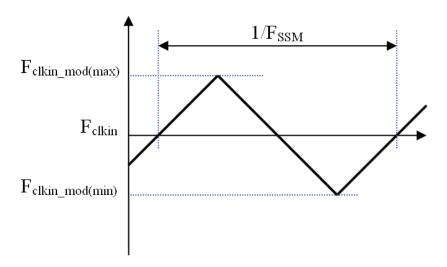
Note (1) The input clock cycle-to-cycle jitter is defined as below figures. Trcl = IT1 - TI



Note (2) Input Clock to data skew is defined as below figures.



Note (3) The SSCG (Spread spectrum clock generator) is defined as below figures.



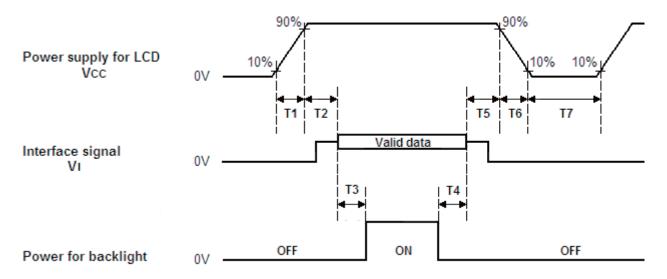
The DCLK range at last line of V-blank should be set in 0 to Hdisplay/2

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4.6 POWER ON/OFF SEQUENCE

The power sequence specifications are shown as the following table and diagram.



Timing Specifications:

Parameters		Units		
i arameters	Min	Тур.	Max	Offics
T1	0.5		10	ms
T2	50		100	ms
T3	450			ms
T4	90			ms
T5	0		50	ms
T6	0.1		100	ms
T7	500			ms

- Note (1) The supply voltage of the external system for the module input should be the same as the definition of Vcc.
- Note (2) When the backlight turns on before the LCD operation of the LCD turns off, the display may momentarily become abnormal screen.
- Note (3) In case of VCC = off level, please keep the level of input signals on the low or keep a high impedance.
- Note (4) T4 should be measured after the module has been fully discharged between power off and on period.
- Note (5) Interface signal shall not be kept at high impedance when the power is on.
- Note (6) INX won't take any responsibility for the products which are damaged by the customers not following the Power Sequence.
- Note (7) There might be slight electronic noise when LCD is turned off (even backlight unit is also off). To avoid this symptom, we suggest "Vcc falling timing" to follow "t6 spec".



5. OPTICAL CHARACTERISTICS

5.1 TEST CONDITIONS

Item	Symbol	Value	Unit					
Ambient Temperature	Ta	25±2	оС					
Ambient Humidity	На	50±10	%RH					
Supply Voltage	VCC	5	V					
Input Signal	According to typical value in "3. ELECTRICAL CHARACTERISTIC							
LED Light Bar Input Current Per Input Pin	IPIN	75± 2.55	mA					
PWM Duty Ratio	D	100	%					
LED Light Bar Test Converter	INX 35-D084290							

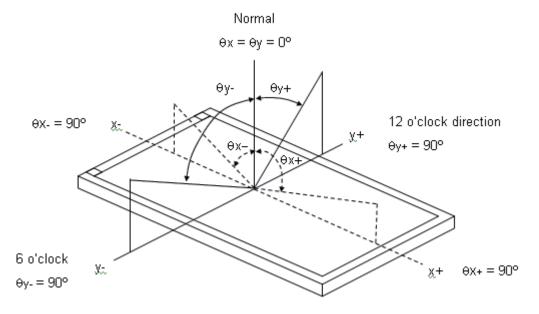
5.2 OPTICAL SPECIFICATIONS

The relative measurement methods of optical characteristics are shown in 5.2. The following items should be measured under the test conditions described in 5.1 and stable environment shown in Note (5).

Iter	n	Symbol	Condition	Min.	Тур.	Max.	Unit	Note
	Red	Rx			0.639			
	neu	Ry			0.339			
	Green	Gx			0.314			
Color Chromaticity	Green	Gy		Typ – 0.03	0.627	Тур +	_	(1) (5)
(CIE 1931)	Blue	Bx	$\theta_x = 0^\circ, \ \theta_Y = 0^\circ$		0.156	0.03	_	(1), (5)
(0.2 .00.)	Diue	Ву	CS-2000 R=G=B=255		0.057			
	White	Wx	Gray scale		0.313			
	vvriite	Wy			0.329			
	Center Luminance of White (Center of Screen)			250	300	-	cd/m ²	(4), (5)
Contrast	Ratio	CR		800	1200	-	-	(2), (5)
Respons	a Tima	T_R	$\theta_x=0^\circ, \ \theta_Y=0^\circ$	-	1.5	2.5	ms	(3)
riespons	e mile	T _F	υ _χ =υ , υγ =υ	-	3.5	5.5	1113	(0)
White Va	ariation	δW	θ_x =0°, θ_Y =0° USB2000		ı	1.42	-	(5), (6)
Viewing Angle	Horizontal	$\theta x - + \theta x +$	CR ≥ 10	150	170	-	Deg.	(1), (5)
Viewing Angle	Vertical	θ y- + θ y+	USB2000	140	160	-	Deg.	(1), (3)
Viewing Angle	Horizontal	$\theta x - + \theta x +$	CR ≥ 5	160	178	-	Deg.	(1), (5)
viewing Angle	Vertical	θ y- + θ y+	USB2000	150	170	-	Deg.	(1), (3)



Note (1) Definition of Viewing Angle (θx , θy):



Note (2) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) = L255 / L0

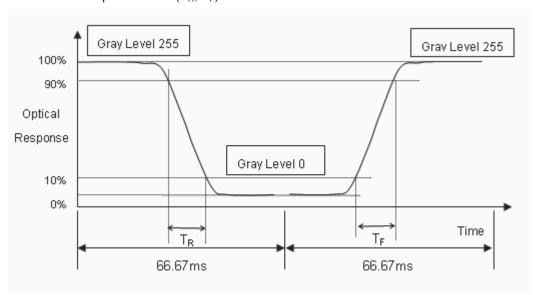
L255: Luminance of gray level 255

L 0: Luminance of gray level 0

CR = CR(5)

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (6).

Note (3) Definition of Response Time (T_R, T_F):





Note (4) Definition of Luminance of White (L_C):

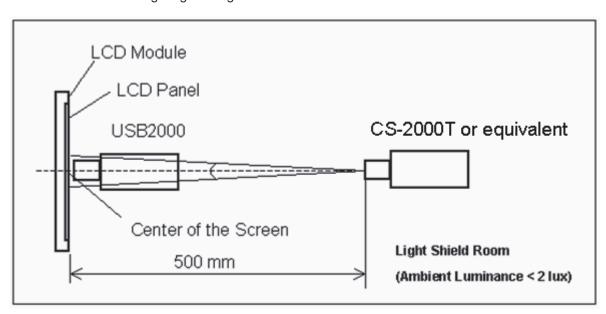
Measure the luminance of gray level 255 at center point

$$L_{C} = L(5)$$

L (x) is corresponding to the luminance of the point X at Figure in Note (6).

Note (5) Measurement Setup:

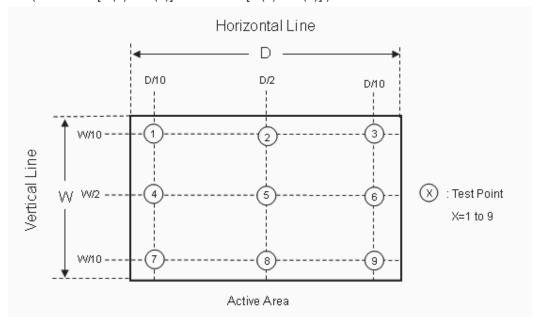
The LCD module should be stabilized at given temperature for 40 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 40 minutes in a windless room.



Note (6) Definition of White Variation (δW):

Measure the luminance of gray level 255 at 9 points

 $\delta W = (Minimum [L (1) \sim L (9)] / Maximum [L (1) \sim L (9)]) *100%$



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6. RELIABILITY TEST ITEM

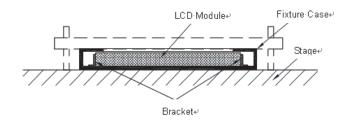
Items	Required Condition	Note
Temperature Humidity Bias (THB)	Ta= 50 °C , 80%RH, 240hours	
High Temperature Operation (HTO)	Ta= 50°C , 240hours	
Low Temperature Operation (LTO)	Ta= 0°C , 240hours	
High Temperature Storage (HTS)	Ta= 60° C , 240hours	
Low Temperature Storage (LTS)	Ta= -20° C , 240hours	
Vibration Test (Non-operation)	Acceleration: 1.5 G Wave: sine Frequency: 10 - 300 Hz Sweep: 30 Minutes each Axis (X, Y, Z)	
Shock Test (Non-operation)	Acceleration: 50 G Wave: Half-sine Active Time: 11 ms Direction: ± X, ± Y, ± Z.(one time for each Axis)	
Thermal Shock Test (TST)	-20°C/30min , 60°C / 30min , 100 cycles	
On/Off Test	25°C ,On/10sec , Off /10sec , 30,000 cycles	
ESD (Electro Static Discharge)	Contact Discharge: ± 8KV, 150pF(330Ω)	
	Air Discharge: \pm 15KV, 150pF(330 Ω)	
Altitude Test	Operation:10,000 ft / 24hours Non-Operation:30,000 ft / 24hours	

Note (1) criteria: Normal display image with no obvious non-uniformity and no line defect.

Note (2) Evaluation should be tested after storage at room temperature for more than two hour

Note (3) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.

The fixing condition is shown as below:





7. MECHANICAL STRENGTH CHARACTERISTICS

7.1 MECHANICAL STRENGTH SPECIFICATIONS

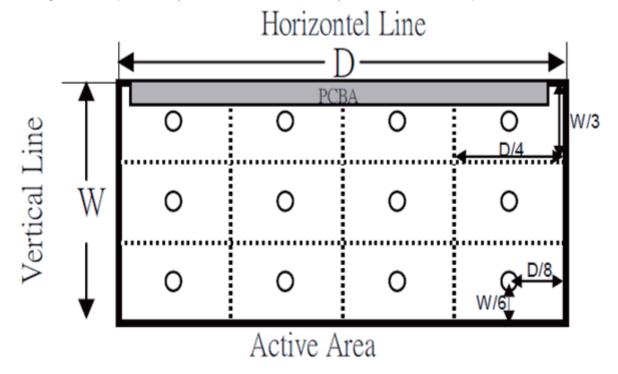
ltem	Condition	Min	Unit	Note
Mechanical Strength	128 th Gray Pattern	0.6	Kgf	

7.2 TEST CONDITIONS

Items	Description
Test Condition	1. Ambient Illumination: 10~15 lux 2. Test Pattern: 128 Gray 3. Distance of the judgment: 30cm from the surface of module 4. Viewing angle of the judgment: Front
Gage Information	Push pull guage a. Model name : HF-50, maker : ALGOL b. Shape of gage tip - Diameter : 2mm - Thickness : 2mm
Definition of Minimum force	To measure minimum force when operator detects any white spot and light leakage that have occurred while operator presses on back side of module with push pull gage.

7.3 DEFINITION OF TEST POINTS

Measure the minimum force of test points at 128th Gray pattern. The test points at back side of module area is showing as below (If the test points on the PCBA, these points are not included).



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8. PACKING

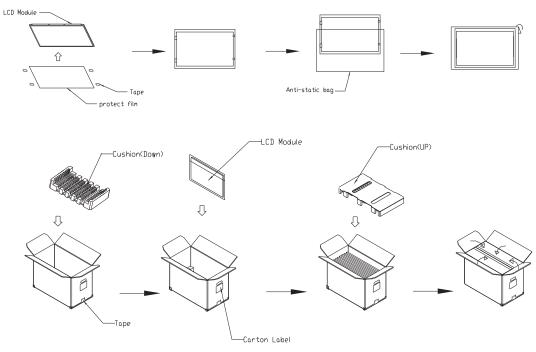
8.1 PACKING SPECIFICATIONS

(1) 10 LCD modules / 1 Box

(2) Box dimensions: 713 (L) X 429 (W) X 453 (H) mm

(3) Weight: approximately: 29.7Kg (10 modules per box)

8.2 PACKING METHOD



1.Carton dimensions: 713(L)x429(W)x453(H)mm

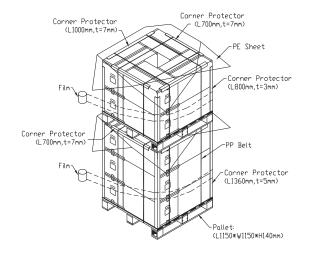
2. 10 modules / carton

Figure. 8-1 Packing method

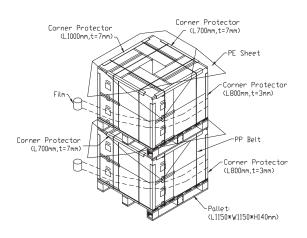
8.3 PALLET

For ocean shipping

Sea / Land Transportation (40ft HQ Container)



Sea / Land Transportation (40ft Container)



Air Transportation

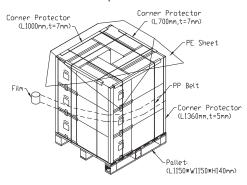


Figure. 8-2 Packing method



8.4 UN-PACKING METHOD

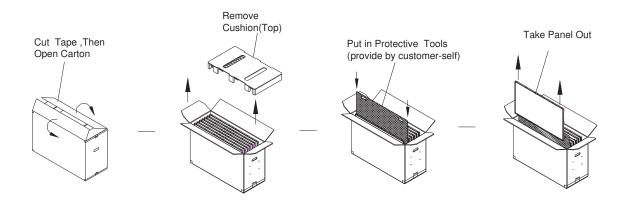


Figure. 8-3 UN-Packing method



9. INX MODULE LABEL

The barcode nameplate is pasted on each module as illustration, and its definitions are as following explanation.



(a) Model Name: M270HGE-L30

(b) Revision: Rev. XX, for example: A0, A1... B1, B2... or C1, C2...etc.

(c) INX barcode definition:

Serial ID: XX-XX-X-XX-YMD-L-NNNN

Code	Meaning	Description
XX	INX internal use	-
XX	Revision	Cover all the change
Х	INX internal use	
XX	INX internal use	-
YMD	Year, month, day	Year: 0~9, 2001=1, 2002=2, 2003=32010=0, 2011=1, 2012=2 Month: 1~12=1, 2, 3, ~, 9, A, B, C Day: 1~31=1, 2, 3, ~, 9, A, B, C, ~, W, X, Y, exclude I, O, and U.
L	Product line #	Line 1=1, Line 2=2, Line 3=3,
NNNN	Serial number	Manufacturing sequence of product

(d) Customer's barcode definition:

Serial ID: CM-R0E30-X-X-X-XX-L-XX-L-YMD-NNNN

Code	Meaning	Description	
CM	Supplier code	INX=CM	
R0E30	Model number	M270HGE-L30= R0E30	
Х	Revision code	Non ZBD: 1,2,~,8,9 / ZBD: A~Z	
X	Source driver IC code	Century=1, CLL=2, Demos=3, Epson=4, Fujitsu=5, Himax=6, Hitachi=7, Hynix=8, LDI=9, Matsushita=A, NEC=B, Novatec=C, OKI=D, Philips=E, Renasas=F, Samsung=G, Sanyo=H, Sharp=I, TI=J Topro=K, Toshiba=L, Windbond=M, ILITEK=Q, Fiti=Y, None IC =Z	
Х	Gate driver IC code		
XX	Cell location	Tainan Taiwan=TN, Ningbo China=CN, Hsinchu Taiwan=SC	
L	Cell line #	1,2,~,9,A,B,~,Y,Z	
XX	Module location	Tainan, Taiwan=TN ; Ningbo China=NP ; Shenzhen China=SH ; Nanhai China=NH	
L	Module line #	1,2,~,9,A,B,~,Y,Z	
YMD	Year, month, day	Year: 0~9, 2001=1, 2002=2, 2003=32010=0, 2011=1, 2012=2 Month: 1~12=1, 2, 3, ~, 9, A, B, C Day: 1~31=1, 2, 3, ~, 9, A, B, C, ~, T, U, V	
NNNN	Serial number	By LCD supplier	





(e) FAB ID(UL Factory ID):

Region	Factory ID	
TWINX	GEMN	
NBCMI	LEOO	
NBCMI	VIRO	
NBCME	CANO	
NHCMI	CAPG	

10. PRECAUTIONS

10.1 ASSEMBLY AND HANDLING PRECAUTIONS

- (1) Do not apply rough force such as bending or twisting to the module during assembly.
- (2) To assemble or install module into user's system can be only in clean working areas. The dust and oil may cause electrical short or worsen the polarizer.
- (3) It's not permitted to have pressure or impulse on the module because the LCD panel and Backlight will be damaged.
- (4) Always follow the correct power sequence when LCD module is connecting and operating. This can prevent damage to the CMOS LSI chips during latch-up.
- (5) Do not pull the I/F connector in or out while the module is operating.
- (6) Do not disassemble the module.
- (7) Use a soft dry cloth without chemicals for cleaning, because the surface of polarizer is very soft and easily scratched.
- (8) It is dangerous that moisture come into or contacted the LCD module, because moisture may damage LCD module when it is operating.
- (9) High temperature or humidity may reduce the performance of module. Please store LCD module within the specified storage conditions.
- (10)When ambient temperature is lower than 10°C may reduce the display quality. For example, the response time will become slowly.

10.2 STORAGE PRECAUTIONS

- (1) Do not leave the module in high temperature, and high humidity for a long time. It is highly recommended to store the module with temperature from 0°C to 35°C and relative humidity of less than 90%
- (2) Do not store the TFT LCD module in direct sunlight
- (3) The module should be stored in dark place. It is prohibited to apply sunlight or fluorescent light in storing

10.3 OPERATION PRECAUTIONS

(1) The LCD product should be operated under normal condition.

Normal condition is defined as below:

Temperature : 20±15℃ Humidity: 65±20%

Display pattern: continually changing pattern(Not stationary)



(2) If the product will be used in extreme conditions such as high temperature, high humidity, high altitude, display pattern or operation time etc...It is strongly recommended to contact CMI for application engineering advice. Otherwise, Its reliability and function may not be guaranteed.

10.4 SAFETY PRECAUTIONS

- (1) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, skin or clothes, it has to be washed away thoroughly with soap.
- (2) After the module's end of life, it is not harmful in case of normal operation and storage.

10.5 SAFETY STANDARDS

The LCD module should be certified with safety regulations as follows:

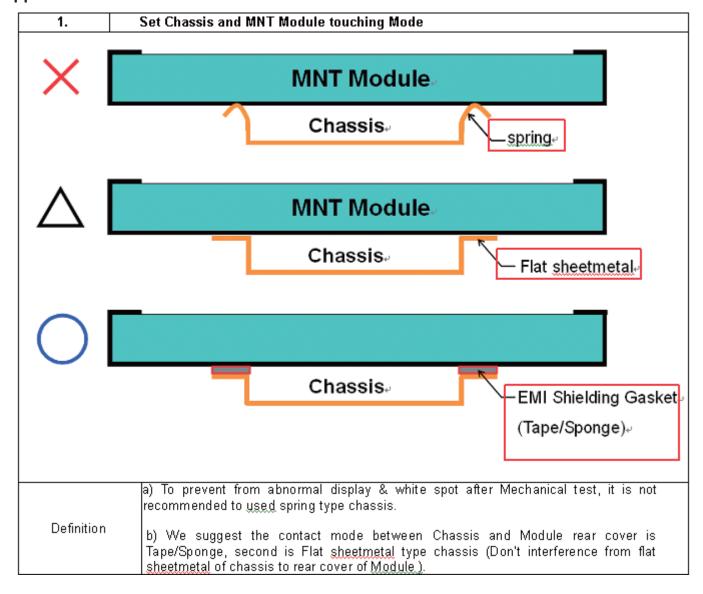
Requirement	Standard	remark
UL	UL60950-1:2006 or Ed.2:2007	
cUL/CSA	CAN/CSA C22.2 No.60950-1-03 or 60950-1-07	
СВ	IEC60950-1:2005 / EN60950-1:2006+ A11:2009	

10.6 OTHER

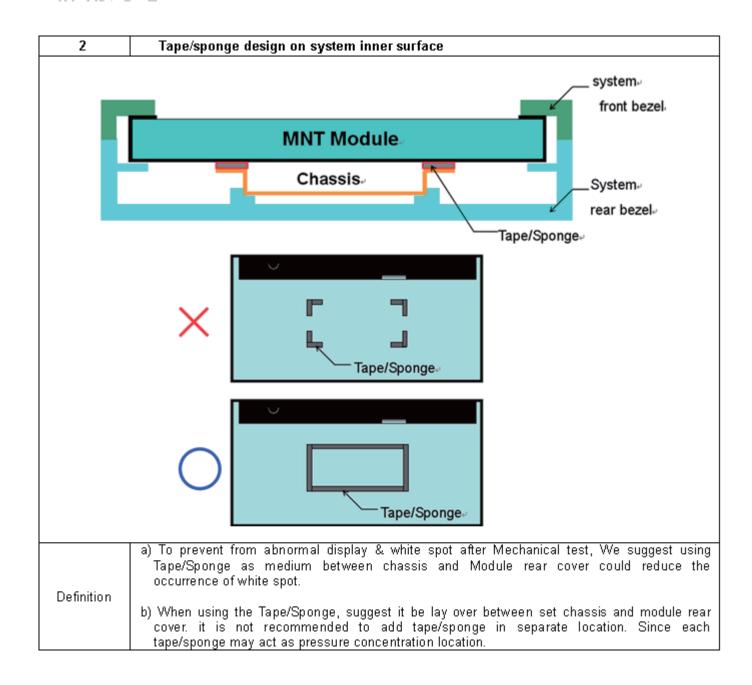
When fixed patterns are displayed for a long time, remnant image is likely to occur.



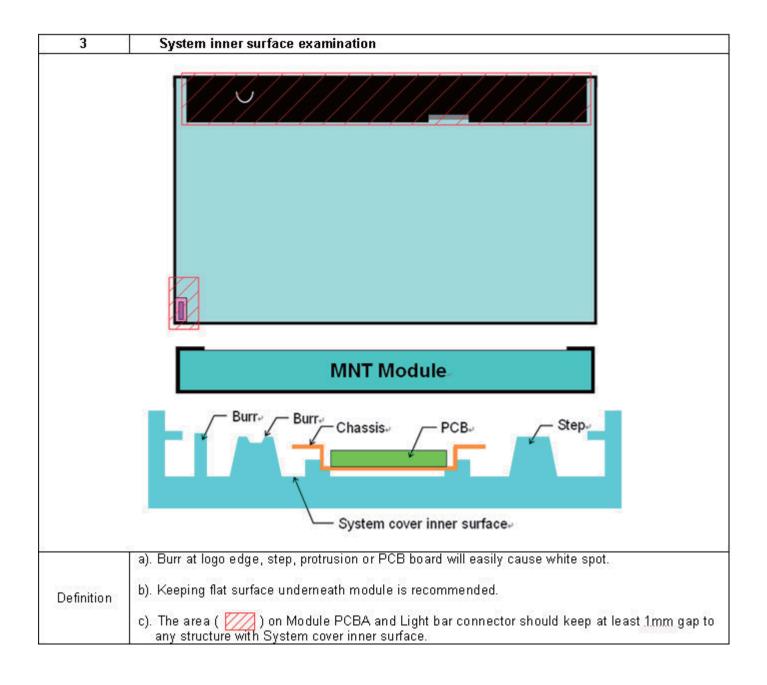
Appendix 1. SYSTEM COVER DESIGN NOTICE



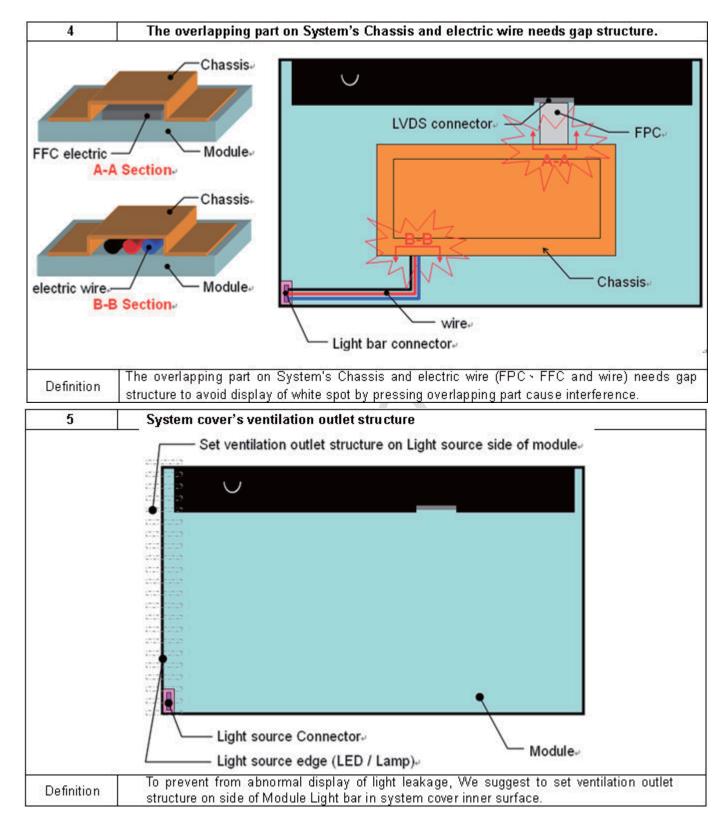












Appendix 2. OUTLINE DRAWING

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